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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	10 ns
Voltage Supply - Internal	1.65V ~ 1.95V
Number of Logic Elements/Blocks	4
Number of Macrocells	64
Number of Gates	-
Number of I/O	30
Operating Temperature	-40°C ~ 105°C (Tj)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4064c-10tn44i

Table 10. ORP Combinations for I/O Blocks with 12 I/Os

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M1, M2, M3, M4, M5, M6, M7, M8
I/O 2	M2, M3, M4, M5, M6, M7, M8, M9
I/O 3	M4, M5, M6, M7, M8, M9, M10, M11
I/O 4	M5, M6, M7, M8, M9, M10, M11, M12
I/O 5	M6, M7, M8, M9, M10, M11, M12, M13
I/O 6	M8, M9, M10, M11, M12, M13, M14, M15
I/O 7	M9, M10, M11, M12, M13, M14, M15, M0
I/O 8	M10, M11, M12, M13, M14, M15, M0, M1
I/O 9	M12, M13, M14, M15, M0, M1, M2, M3
I/O 10	M13, M14, M15, M0, M1, M2, M3, M4
I/O 11	M14, M15, M0, M1, M2, M3, M4, M5

ORP Bypass and Fast Output Multiplexers

The ORP bypass and fast-path output multiplexer is a 4:1 multiplexer and allows the 5-PT fast path to bypass the ORP and be connected directly to the pin with either the regular output or the inverted output. This multiplexer also allows the register output to bypass the ORP to achieve faster t_{CO} .

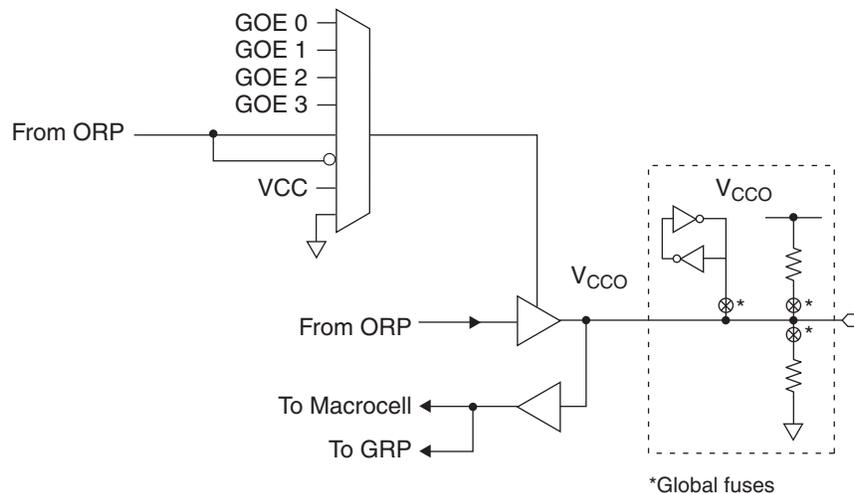
Output Enable Routing Multiplexers

The OE Routing Pool provides the corresponding local output enable (OE) product term to the I/O cell.

I/O Cell

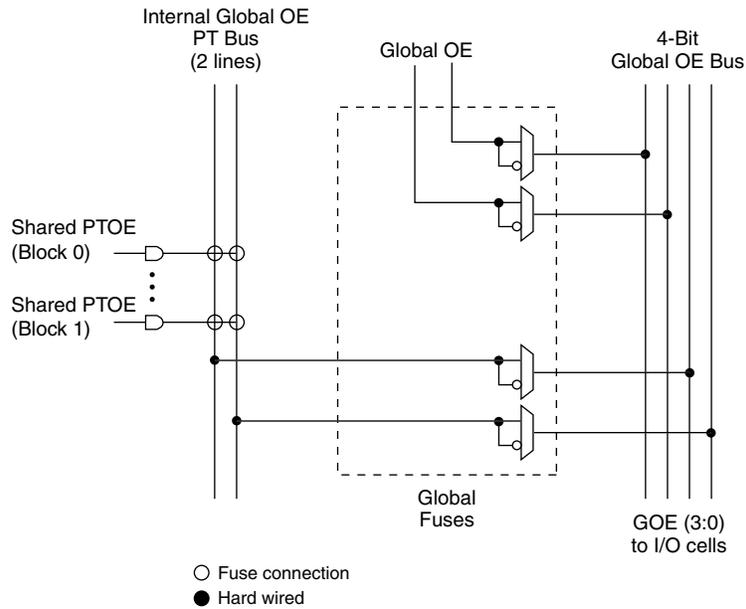
The I/O cell contains the following programmable elements: output buffer, input buffer, OE multiplexer and bus maintenance circuitry. Figure 8 details the I/O cell.

Figure 8. I/O Cell



Each output supports a variety of output standards dependent on the V_{CCO} supplied to its I/O bank. Outputs can also be configured for open drain operation. Each input can be programmed to support a variety of standards, independent of the V_{CCO} supplied to its I/O bank. The I/O standards supported are:

Figure 10. Global OE Generation for ispMACH 4032



Zero Power/Low Power and Power Management

The ispMACH 4000 family is designed with high speed low power design techniques to offer both high speed and low power. With an advanced E² low power cell and non sense-amplifier design approach (full CMOS logic approach), the ispMACH 4000 family offers SuperFAST pin-to-pin speeds, while simultaneously delivering low standby power without needing any “turbo bits” or other power management schemes associated with a traditional sense-amplifier approach.

The zero power ispMACH 4000Z is based on the 1.8V ispMACH 4000C family. With innovative circuit design changes, the ispMACH 4000Z family is able to achieve the industry’s “lowest static power”.

IEEE 1149.1-Compliant Boundary Scan Testability

All ispMACH 4000 devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board-level testing. The test access port operates with an LVCMOS interface that corresponds to the power supply voltage.

I/O Quick Configuration

To facilitate the most efficient board test, the physical nature of the I/O cells must be set before running any continuity tests. As these tests are fast, by nature, the overhead and time that is required for configuration of the I/Os’ physical nature should be minimal so that board test time is minimized. The ispMACH 4000 family of devices allows this by offering the user the ability to quickly configure the physical nature of the I/O cells. This quick configuration takes milliseconds to complete, whereas it takes seconds for the entire device to be programmed. Lattice’s ispVM[®] System programming software can either perform the quick configuration through the PC parallel port, or can generate the ATE or test vectors necessary for a third-party test system.

IEEE 1532-Compliant In-System Programming

Programming devices in-system provides a number of significant benefits including: rapid prototyping, lower inventory levels, higher quality and the ability to make in-field modifications. All ispMACH 4000 devices provide In-System Programming (ISP™) capability through the Boundary Scan Test Access Port. This capability has been implemented in a manner that ensures that the port remains compliant to the IEEE 1149.1 standard. By using IEEE 1149.1 as the communication interface through which ISP is achieved, users get the benefit of a standard, well-defined interface. All ispMACH 4000 devices are also compliant with the IEEE 1532 standard.

The ispMACH 4000 devices can be programmed across the commercial temperature and voltage range. The PC-based Lattice software facilitates in-system programming of ispMACH 4000 devices. The software takes the JEDEC file output produced by the design implementation software, along with information about the scan chain, and creates a set of vectors used to drive the scan chain. The software can use these vectors to drive a scan chain via the parallel port of a PC. Alternatively, the software can output files in formats understood by common automated test equipment. This equipment can then be used to program ispMACH 4000 devices during the testing of a circuit board.

User Electronic Signature

The User Electronic Signature (UES) allows the designer to include identification bits or serial numbers inside the device, stored in E²CMOS memory. The ispMACH 4000 device contains 32 UES bits that can be configured by the user to store unique data such as ID codes, revision numbers or inventory control codes.

Security Bit

A programmable security bit is provided on the ispMACH 4000 devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this bit defeats readback of the programmed pattern by a device programmer, securing proprietary designs from competitors. Programming and verification are also defeated by the security bit. The bit can only be reset by erasing the entire device.

Hot Socketing

The ispMACH 4000 devices are well-suited for applications that require hot socketing capability. Hot socketing a device requires that the device, during power-up and down, can tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of I/O pin loading be minimal on active signals. The ispMACH 4000 devices provide this capability for input voltages in the range 0V to 3.0V.

Density Migration

The ispMACH 4000 family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is possible to shift a lower utilization design targeted for a high density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

Supply Current, ispMACH 4000V/B/C (Cont.)

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I _{CC} ⁴	Standby Power Supply Current	V _{CC} = 3.3V	—	13	—	mA
		V _{CC} = 2.5V	—	13	—	mA
		V _{CC} = 1.8V	—	3	—	mA

1. T_A = 25°C, frequency = 1.0 MHz.
2. Device configured with 16-bit counters.
3. I_{CC} varies with specific device configuration and operating frequency.
4. T_A = 25°C

Supply Current, ispMACH 4000Z

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
ispMACH 4032ZC						
ICC ^{1,2,3,5}	Operating Power Supply Current	V _{CC} = 1.8V, T _A = 25°C	—	50	—	μA
		V _{CC} = 1.9V, T _A = 70°C	—	58	—	μA
		V _{CC} = 1.9V, T _A = 85°C	—	60	—	μA
		V _{CC} = 1.9V, T _A = 125°C	—	70	—	μA
ICC ^{4,5}	Standby Power Supply Current	V _{CC} = 1.8V, T _A = 25°C	—	10	—	μA
		V _{CC} = 1.9V, T _A = 70°C	—	13	20	μA
		V _{CC} = 1.9V, T _A = 85°C	—	15	25	μA
		V _{CC} = 1.9V, T _A = 125°C	—	22	—	μA
ispMACH 4064ZC						
ICC ^{1,2,3,5}	Operating Power Supply Current	V _{CC} = 1.8V, T _A = 25°C	—	80	—	μA
		V _{CC} = 1.9V, T _A = 70°C	—	89	—	μA
		V _{CC} = 1.9V, T _A = 85°C	—	92	—	μA
		V _{CC} = 1.9V, T _A = 125°C	—	109	—	μA
ICC ^{4,5}	Standby Power Supply Current	V _{CC} = 1.8V, T _A = 25°C	—	11	—	μA
		V _{CC} = 1.9V, T _A = 70°C	—	15	25	μA
		V _{CC} = 1.9V, T _A = 85°C	—	18	35	μA
		V _{CC} = 1.9V, T _A = 125°C	—	37	—	μA
ispMACH 4128ZC						
ICC ^{1,2,3,5}	Operating Power Supply Current	V _{CC} = 1.8V, T _A = 25°C	—	168	—	μA
		V _{CC} = 1.9V, T _A = 70°C	—	190	—	μA
		V _{CC} = 1.9V, T _A = 85°C	—	195	—	μA
		V _{CC} = 1.9V, T _A = 125°C	—	212	—	μA
ICC ^{4,5}	Standby Power Supply Current	V _{CC} = 1.8V, T _A = 25°C	—	12	—	μA
		V _{CC} = 1.9V, T _A = 70°C	—	16	35	μA
		V _{CC} = 1.9V, T _A = 85°C	—	19	50	μA
		V _{CC} = 1.9V, T _A = 125°C	—	42	—	μA

ispMACH 4000Z External Switching Characteristics

Over Recommended Operating Conditions

Parameter	Description ^{1, 2, 3}	-35		-37		-42		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t _{PD}	5-PT bypass combinatorial propagation delay	—	3.5	—	3.7	—	4.2	ns
t _{PD_MC}	20-PT combinatorial propagation delay through macrocell	—	4.4	—	4.7	—	5.7	ns
t _S	GLB register setup time before clock	2.2	—	2.5	—	2.7	—	ns
t _{ST}	GLB register setup time before clock with T-type register	2.4	—	2.7	—	2.9	—	ns
t _{SIR}	GLB register setup time before clock, input register path	1.0	—	1.1	—	1.3	—	ns
t _{SIRZ}	GLB register setup time before clock with zero hold	2.0	—	2.1	—	2.6	—	ns
t _H	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	ns
t _{HT}	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	ns
t _{HIR}	GLB register hold time after clock, input register path	1.0	—	1.0	—	1.3	—	ns
t _{HIRZ}	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	ns
t _{CO}	GLB register clock-to-output delay	—	3.0	—	3.2	—	3.5	ns
t _R	External reset pin to output delay	—	5.0	—	6.0	—	7.3	ns
t _{RW}	External reset pulse duration	1.5	—	1.7	—	2.0	—	ns
t _{P_{TOE/DIS}}	Input to output local product term output enable/disable	—	7.0	—	8.0	—	8.0	ns
t _{G_PTOE/DIS}	Input to output global product term output enable/disable	—	6.5	—	7.0	—	8.0	ns
t _{GOE/DIS}	Global OE input to output enable/disable	—	4.5	—	4.5	—	4.8	ns
t _{CW}	Global clock width, high or low	1.0	—	1.5	—	1.8	—	ns
t _{GW}	Global gate width low (for low transparent) or high (for high transparent)	1.0	—	1.5	—	1.8	—	ns
t _{WIR}	Input register clock width, high or low	1.0	—	1.5	—	1.8	—	ns
f _{MAX} ⁴	Clock frequency with internal feedback	—	267	—	250	—	220	MHz
f _{MAX} (Ext.)	clock frequency with external feedback, [1 / (t _S + t _{CO})]	—	192	—	175	—	161	MHz

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.2.2

2. Measured using standard switching GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

ispMACH 4000V/B/C Internal Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-5		-75		-10		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t _{GP} TOE	Global PT OE Delay	—	5.58	—	5.58	—	5.78	ns
t _P TOE	Macrocell PT OE Delay	—	3.58	—	4.28	—	4.28	ns

Timing v.3.2

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the Timing Model in this data sheet for further details.

ispMACH 4000Z Internal Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-45		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t _{P_{TOE}}	Macrocell PT OE Delay	—	2.50	—	2.70	—	2.00	ns

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the timing model in this data sheet for further details. Timing v.2.2

ispMACH 4000V/B/C Timing Adders¹ (Cont.)

Adder Type	Base Parameter	Description	-5		-75		-10		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
Optional Delay Adders									
t_{INDIO}	t_{INREG}	Input register delay	—	1.00	—	1.00	—	1.00	ns
t_{EXP}	t_{MCELL}	Product term expander delay	—	0.33	—	0.33	—	0.33	ns
t_{ORP}	—	Output routing pool delay	—	0.05	—	0.05	—	0.05	ns
t_{BLA}	t_{ROUTE}	Additional block loading adder	—	0.05	—	0.05	—	0.05	ns
t_{IOI} Input Adjusters									
LVTTTL_in	$t_{IN}, t_{GCLK_IN}, t_{GOE}$	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	$t_{IN}, t_{GCLK_IN}, t_{GOE}$	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	$t_{IN}, t_{GCLK_IN}, t_{GOE}$	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	$t_{IN}, t_{GCLK_IN}, t_{GOE}$	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	$t_{IN}, t_{GCLK_IN}, t_{GOE}$	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
t_{IOO} Output Adjusters									
LVTTTL_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t_{BUF}, t_{EN}	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

Boundary Scan Waveforms and Timing Specifications

Symbol	Parameter	Min.	Max.	Units
t_{BTCP}	TCK [BSCAN test] clock cycle	40	—	ns
t_{BTCH}	TCK [BSCAN test] pulse width high	20	—	ns
t_{BTCL}	TCK [BSCAN test] pulse width low	20	—	ns
t_{BTSU}	TCK [BSCAN test] setup time	8	—	ns
t_{BTH}	TCK [BSCAN test] hold time	10	—	ns
t_{BRF}	TCK [BSCAN test] rise and fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
t_{BTOZ}	TAP controller falling edge of clock to data output disable	—	10	ns
t_{BTVO}	TAP controller falling edge of clock to data output enable	—	10	ns
t_{BTCPSU}	BSCAN test Capture register setup time	8	—	ns
t_{BTCPH}	BSCAN test Capture register hold time	10	—	ns
t_{BTUCO}	BSCAN test Update reg, falling edge of clock to valid output	—	25	ns
t_{BTUOZ}	BSCAN test Update reg, falling edge of clock to output disable	—	25	ns
t_{BTUOV}	BSCAN test Update reg, falling edge of clock to output enable	—	25	ns

**ispMACH 4032V/B/C/Z and 4064V/B/C/Z Logic Signal Connections:
48-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4032V/B/C/Z		ispMACH 4064V/B/C		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
33	1	B10	B [^] 10	D4	D [^] 2	D10	D [^] 5
34	1	B11	B [^] 11	D6	D [^] 3	D8	D [^] 4
35	-	TDO	-	TDO	-	TDO	-
36	-	VCC	-	VCC	-	VCC	-
37	-	GND	-	GND	-	GND	-
38	1	B12	B [^] 12	D8	D [^] 4	D6	D [^] 3
39	1	B13	B [^] 13	D10	D [^] 5	D4	D [^] 2
40	1	B14	B [^] 14	D12	D [^] 6	D2	D [^] 1
41	1	B15/GOE1	B [^] 15	D14/GOE1	D [^] 7	D0/GOE1	D [^] 0
42	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
43	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
44	0	A0/GOE0	A [^] 0	A0/GOE0	A [^] 0	A0/GOE0	A [^] 0
45	0	A1	A [^] 1	A2	A [^] 1	A1	A [^] 1
46	0	A2	A [^] 2	A4	A [^] 2	A2	A [^] 2
47	0	A3	A [^] 3	A6	A [^] 3	A4	A [^] 3
48	0	A4	A [^] 4	A8	A [^] 4	A6	A [^] 4

ispMACH 4032Z and 4064Z Logic Signal Connections: 56-Ball csBGA

Ball Number	Bank Number	ispMACH 4032Z		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
B1	-	TDI	-	TDI	-
C3	0	A5	A [^] 5	A8	A [^] 5
C1	0	A6	A [^] 6	A10	A [^] 6
D1	0	A7	A [^] 7	A11	A [^] 7
D3	0	GND (Bank 0)	-	GND (Bank 0)	-
E3	0	NC ¹	-	I ¹	-
E1	0	NC ¹	-	I ¹	-
F3	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-
F1	0	A8	A [^] 8	B15	B [^] 7
G3	0	A9	A [^] 9	B12	B [^] 6
G1	0	A10	A [^] 10	B10	B [^] 5
H1	0	A11	A [^] 11	B8	B [^] 4
J1	0	NC	-	I	-
K1	-	TCK	-	TCK	-
K2	-	VCC	-	VCC	-
H3	-	GND	-	GND	-
K3	-	NC ¹	-	I ¹	-
K4	0	A12	A [^] 12	B6	B [^] 3
H4	0	A13	A [^] 13	B4	B [^] 2
H5	0	A14	A [^] 14	B2	B [^] 1

ispMACH 4032Z and 4064Z Logic Signal Connections: 56-Ball csBGA (Cont.)

Ball Number	Bank Number	ispMACH 4032Z		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
K5	0	A15	A ¹⁵	B0	B ⁰
H6	0	CLK1/I	-	CLK1/I	-
K6	1	CLK2/I	-	CLK2/I	-
H7	1	B0	B ⁰	C0	C ⁰
K7	1	B1	B ¹	C1	C ¹
K8	1	B2	B ²	C2	C ²
K9	1	B3	B ³	C4	C ³
K10	1	B4	B ⁴	C6	C ⁴
J10	-	TMS	-	TMS	-
H8	1	B5	B ⁵	C8	C ⁵
H10	1	B6	B ⁶	C10	C ⁶
G10	1	B7	B ⁷	C11	C ⁷
G8	1	GND (Bank 1)	-	GND (Bank 1)	-
F8	1	NC ¹	-	I ¹	-
F10	1	NC ¹	-	I ¹	-
E8	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
E10	1	B8	B ⁸	D15	D ⁷
D8	1	B9	B ⁹	D12	D ⁶
D10	1	B10	B ¹⁰	D10	D ⁵
C10	1	B11	B ¹¹	D8	D ⁴
B10	1	NC ¹	-	I ¹	-
A10	-	TDO	-	TDO	-
A9	-	VCC	-	VCC	-
C8	-	GND	-	GND	-
A8	1	NC ¹	-	I ¹	-
A7	1	B12	B ¹²	D6	D ³
C7	1	B13	B ¹³	D4	D ²
C6	1	B14	B ¹⁴	D2	D ¹
A6	1	B15/GOE1	B ¹⁵	D0/GOE1	D ⁰
C5	1	CLK3/I	-	CLK3/I	-
A5	0	CLK0/I	-	CLK0/I	-
C4	0	A0/GOE0	A ⁰	A0/GOE0	A ⁰
A4	0	A1	A ¹	A1	A ¹
A3	0	A2	A ²	A2	A ²
A2	0	A3	A ³	A4	A ³
A1	0	A4	A ⁴	A6	A ⁴

1. For device migration considerations, these NC pins are input signal pins in ispMACH 4064Z devices.

**ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections:
100-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4064V/B/C/Z		ispMACH 4128V/B/C/Z		ispMACH 4256V/B/C/Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
83	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
84	1	D3	D ³	H6	H ³	P12	P ³
85	1	D2	D ²	H4	H ²	P10	P ²
86	1	D1	D ¹	H2	H ¹	P6	P ¹
87	1	D0/GOE1	D ⁰	H0/GOE1	H ⁰	P2/OE1	P ⁰
88	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
89	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
90	-	VCC	-	VCC	-	VCC	-
91	0	A0/GOE0	A ⁰	A0/GOE0	A ⁰	A2/GOE0	A ⁰
92	0	A1	A ¹	A2	A ¹	A6	A ¹
93	0	A2	A ²	A4	A ²	A10	A ²
94	0	A3	A ³	A6	A ³	A12	A ³
95	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
96	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
97	0	A4	A ⁴	A8	A ⁴	B2	B ⁰
98	0	A5	A ⁵	A10	A ⁵	B6	B ¹
99	0	A6	A ⁶	A12	A ⁶	B10	B ²
100	0	A7	A ⁷	A14	A ⁷	B12	B ³

*This pin is input only.

ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
1	0	GND	-
2	0	TDI	-
3	0	VCCO (Bank 0)	-
4	0	B0	B ⁰
5	0	B1	B ¹
6	0	B2	B ²
7	0	B4	B ³
8	0	B5	B ⁴
9	0	B6	B ⁵
10	0	GND (Bank 0)	-
11	0	B8	B ⁶
12	0	B9	B ⁷
13	0	B10	B ⁸
14	0	B12	B ⁹
15	0	B13	B ¹⁰
16	0	B14	B ¹¹
17	0	VCCO (Bank 0)	-
18	0	C14	C ¹¹

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:
132-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
P8	1	NC ¹	-	NC ¹	-	I ¹	-
M8	1	NC	-	E0	E ⁰	I2	I ¹
P9	1	C0	C ⁰	E1	E ¹	I4	I ²
N9	1	C1	C ¹	E2	E ²	I6	I ³
M9	1	C2	C ²	E4	E ³	I8	I ⁴
N10	1	C3	C ³	E5	E ⁴	I10	I ⁵
P10	1	NC	-	E6	E ⁵	I12	I ⁶
M10	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
N11	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
P11	1	NC	-	E8	E ⁶	J2	J ¹
M11	1	C4	C ⁴	E9	E ⁷	J4	J ²
P12	1	C5	C ⁵	E10	E ⁸	J6	J ³
N12	1	C6	C ⁶	E12	E ⁹	J8	J ⁴
P13	1	C7	C ⁷	E13	E ¹⁰	J10	J ⁵
P14	1	NC	-	E14	E ¹¹	J12	J ⁶
N14	-	GND	-	GND	-	GND	-
N13	-	TMS	-	TMS	-	TMS	-
M14	1	NC	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
M12	1	NC	-	F0	F ⁰	K12	K ⁶
M13	1	C8	C ⁸	F1	F ¹	K10	K ⁵
L14	1	C9	C ⁹	F2	F ²	K8	K ⁴
L12	1	C10	C ¹⁰	F4	F ³	K6	K ³
L13	1	C11	C ¹¹	F5	F ⁴	K4	K ²
K14	1	NC	-	F6	F ⁵	K2	K ¹
K13	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
K12	1	NC	-	F8	F ⁶	L12	L ⁶
J13	1	C12	C ¹²	F9	F ⁷	L10	L ⁵
J14	1	C13	C ¹³	F10	F ⁸	L8	L ⁴
J12	1	C14	C ¹⁴	F12	F ⁹	L6	L ³
H14	1	C15	C ¹⁵	F13	F ¹⁰	L4	L ²
H13	1	I	-	F14	F ¹¹	L2	L ¹
H12	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
G13	1	NC	-	G14	G ¹¹	M2	M ¹
G14	1	NC	-	G13	G ¹⁰	M4	M ²
G12	1	D15	D ¹⁵	G12	G ⁹	M6	M ³
F14	1	D14	D ¹⁴	G10	G ⁸	M8	M ⁴
F13	1	D13	D ¹³	G9	G ⁷	M10	M ⁵
F12	1	D12	D ¹²	G8	G ⁶	M12	M ⁶
E13	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
E14	1	NC	-	G6	G ⁵	N2	N ¹
E12	1	D11	D ¹¹	G5	G ⁴	N4	N ²

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:
256-Ball ftBGA/fpBGA**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
-	-	-	-	-	-	VCC	-	VCC	-
-	-	GND	-	GND	-	GND	-	GND	-
C3	-	TDI	-	TDI	-	TDI	-	TDI	-
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
B1	0	C14	C^7	C14	C^9	C14	C^7	C14	C^7
F5	0	C12	C^6	C12	C^8	C12	C^6	C12	C^6
D3	0	C10	C^5	C10	C^7	C10	C^5	C10	C^5
C1	0	C8	C^4	C9	C^6	C8	C^4	C8	C^4
C2	0	C6	C^3	C8	C^5	C6	C^3	C6	C^3
E3	0	C4	C^2	C6	C^4	C4	C^2	C4	C^2
D2	0	C2	C^1	C4	C^3	C2	C^1	C2	C^1
F6	0	C0	C^0	C2	C^2	C0	C^0	C0	C^0
D1	0	NC	-	C1	C^1	F6	F^3	H0	H^0
E2	0	NC	-	C0	C^0	F4	F^2	H4	H^1
E4	0	NC	-	NC	-	D6	D^3	F4	F^2
G5	0	NC	-	NC	-	D4	D^2	F6	F^3
E1	0	NC	-	NC	-	NC	-	F8	F^4
-	0	-	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
F2	0	NC	-	NC	-	NC	-	F10	F^5
F1	0	NC	-	NC	-	D2	D^1	F12	F^6
G1	0	NC	-	NC	-	D0	D^0	F14	F^7
G6	0	NC	-	D14	D^9	F2	F^1	H8	H^2
G4	0	NC	-	D12	D^8	F0	F^0	H12	H^3
H6	0	D14	D^7	D10	D^7	E14	E^7	G14	G^7
G3	0	D12	D^6	D9	D^6	E12	E^6	G12	G^6
H5	0	D10	D^5	D8	D^5	E10	E^5	G10	G^5
G2	0	D8	D^4	D6	D^4	E8	E^4	G8	G^4
H1	0	D6	D^3	D4	D^3	E6	E^3	G6	G^3
H2	0	D4	D^2	D2	D^2	E4	E^2	G4	G^2
H3	0	D2	D^1	D1	D^1	E2	E^1	G2	G^1
H4	0	D0	D^0	D0	D^0	E0	E^0	G0	G^0
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
-	0	-	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
J4	0	E0	E^0	E0	E^0	H0	H^0	J0	J^0
J3	0	E2	E^1	E1	E^1	H2	H^1	J2	J^1
J2	0	E4	E^2	E2	E^2	H4	H^2	J4	J^2
J1	0	E6	E^3	E4	E^3	H6	H^3	J6	J^3
K1	0	E8	E^4	E6	E^4	H8	H^4	J8	J^4
J5	0	E10	E^5	E8	E^5	H10	H^5	J10	J^5
K2	0	E12	E^6	E9	E^6	H12	H^6	J12	J^6

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
J6	0	E14	E ⁷	E10	E ⁷	H14	H ⁷	J14	J ⁷
K3	0	NC	-	E12	E ⁸	G0	G ⁰	I0	I ⁰
K4	0	NC	-	E14	E ⁹	G2	G ¹	I4	I ¹
L1	0	NC	-	NC	-	I14	I ⁷	K0	K ⁰
L2	0	NC	-	NC	-	I12	I ⁶	K2	K ¹
M1	0	NC	-	NC	-	NC	-	K4	K ²
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
-	0	-	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
M2	0	NC	-	NC	-	NC	-	K6	K ³
N1	0	NC	-	NC	-	I10	I ⁵	K8	K ⁴
M3	0	NC	-	NC	-	I8	I ⁴	K10	K ⁵
M4	0	NC	-	F0	F ⁰	G4	G ²	I8	I ²
N2	0	NC	-	F1	F ¹	G6	G ³	I12	I ³
K5	0	F0	F ⁰	F2	F ²	J0	J ⁰	N0	N ⁰
P1	0	F2	F ¹	F4	F ³	J2	J ¹	N2	N ¹
K6	0	F4	F ²	F6	F ⁴	J4	J ²	N4	N ²
N3	0	F6	F ³	F8	F ⁵	J6	J ³	N6	N ³
L5	0	F8	F ⁴	F9	F ⁶	J8	J ⁴	N8	N ⁴
P2	0	F10	F ⁵	F10	F ⁷	J10	J ⁵	N10	N ⁵
L6	0	F12	F ⁶	F12	F ⁸	J12	J ⁶	N12	N ⁶
R1	0	F14	F ⁷	F14	F ⁹	J14	J ⁷	N14	N ⁷
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
P3	-	TCK	-	TCK	-	TCK	-	TCK	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
-	-	GND	-	GND	-	GND	-	GND	-
-	0	-	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
T2	0	NC	-	G14	G ⁹	I6	I ³	K12	K ⁶
M5	0	NC	-	G12	G ⁸	I4	I ²	K14	K ⁷
N4	0	G14	G ⁷	G10	G ⁷	K14	K ⁷	O14	O ⁷
T3	0	G12	G ⁶	G9	G ⁶	K12	K ⁶	O12	O ⁶
R3	0	G10	G ⁵	G8	G ⁵	K10	K ⁵	O10	O ⁵
M6	0	G8	G ⁴	G6	G ⁴	K8	K ⁴	O8	O ⁴
P4	0	G6	G ³	G4	G ³	K6	K ³	O6	O ³
L7	0	G4	G ²	G2	G ²	K4	K ²	O4	O ²
N5	0	G2	G ¹	G1	G ¹	K2	K ¹	O2	O ¹
M7	0	G0	G ⁰	G0	G ⁰	K0	K ⁰	O0	O ⁰
P5	0	NC	-	NC	-	G8	G ⁴	M0	M ⁰
R4	0	NC	-	NC	-	G10	G ⁵	M4	M ¹
T4	0	NC	-	NC	-	NC	-	L0	L ⁰
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-

ispMACH 4000C (1.8V) Industrial Devices

Family	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032C	LC4032C-5T48I	32	1.8	5	TQFP	48	32	I
	LC4032C-75T48I	32	1.8	7.5	TQFP	48	32	I
	LC4032C-10T48I	32	1.8	10	TQFP	48	32	I
	LC4032C-5T44I	32	1.8	5	TQFP	44	30	I
	LC4032C-75T44I	32	1.8	7.5	TQFP	44	30	I
	LC4032C-10T44I	32	1.8	10	TQFP	44	30	I
LC4064C	LC4064C-5T100I	64	1.8	5	TQFP	100	64	I
	LC4064C-75T100I	64	1.8	7.5	TQFP	100	64	I
	LC4064C-10T100I	64	1.8	10	TQFP	100	64	I
	LC4064C-5T48I	64	1.8	5	TQFP	48	32	I
	LC4064C-75T48I	64	1.8	7.5	TQFP	48	32	I
	LC4064C-10T48I	64	1.8	10	TQFP	48	32	I
	LC4064C-5T44I	64	1.8	5	TQFP	44	30	I
	LC4064C-75T44I	64	1.8	7.5	TQFP	44	30	I
LC4128C	LC4128C-5T128I	128	1.8	5	TQFP	128	92	I
	LC4128C-75T128I	128	1.8	7.5	TQFP	128	92	I
	LC4128C-10T128I	128	1.8	10	TQFP	128	92	I
	LC4128C-5T100I	128	1.8	5	TQFP	100	64	I
	LC4128C-75T100I	128	1.8	7.5	TQFP	100	64	I
	LC4128C-10T100I	128	1.8	10	TQFP	100	64	I
LC4256C	LC4256C-5FT256AI	256	1.8	5	ftBGA	256	128	I
	LC4256C-75FT256AI	256	1.8	7.5	ftBGA	256	128	I
	LC4256C-10FT256AI	256	1.8	10	ftBGA	256	128	I
	LC4256C-5FT256BI	256	1.8	5	ftBGA	256	160	I
	LC4256C-75FT256BI	256	1.8	7.5	ftBGA	256	160	I
	LC4256C-10FT256BI	256	1.8	10	ftBGA	256	160	I
	LC4256C-5F256AI ¹	256	1.8	5	fpBGA	256	128	I
	LC4256C-75F256AI ¹	256	1.8	7.5	fpBGA	256	128	I
	LC4256C-10F256AI ¹	256	1.8	10	fpBGA	256	128	I
	LC4256C-5F256BI ¹	256	1.8	5	fpBGA	256	160	I
	LC4256C-75F256BI ¹	256	1.8	7.5	fpBGA	256	160	I
	LC4256C-10F256BI ¹	256	1.8	10	fpBGA	256	160	I
	LC4256C-5T176I	256	1.8	5	TQFP	176	128	I
	LC4256C-75T176I	256	1.8	7.5	TQFP	176	128	I
	LC4256C-10T176I	256	1.8	10	TQFP	176	128	I
	LC4256C-5T100I	256	1.8	5	TQFP	100	64	I
	LC4256C-75T100I	256	1.8	7.5	TQFP	100	64	I
	LC4256C-10T100I	256	1.8	10	TQFP	100	64	I

ispMACH 4000C (1.8V) Industrial Devices (Cont.)

Family	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4384C	LC4384C-5FT256I	384	1.8	5	ftBGA	256	192	I
	LC4384C-75FT256I	384	1.8	7.5	ftBGA	256	192	I
	LC4384C-10FT256I	384	1.8	10	ftBGA	256	192	I
	LC4384C-5F256I ¹	384	1.8	5	fpBGA	256	192	I
	LC4384C-75F256I ¹	384	1.8	7.5	fpBGA	256	192	I
	LC4384C-10F256I ¹	384	1.8	10	fpBGA	256	192	I
	LC4384C-5T176I	384	1.8	5	TQFP	176	128	I
	LC4384C-75T176I	384	1.8	7.5	TQFP	176	128	I
	LC4384C-10T176I	384	1.8	10	TQFP	176	128	I
LC4512C	LC4512C-5FT256I	512	1.8	5	ftBGA	256	208	I
	LC4512C-75FT256I	512	1.8	7.5	ftBGA	256	208	I
	LC4512C-10FT256I	512	1.8	10	ftBGA	256	208	I
	LC4512C-5F256I ¹	512	1.8	5	fpBGA	256	208	I
	LC4512C-75F256I ¹	512	1.8	7.5	fpBGA	256	208	I
	LC4512C-10F256I ¹	512	1.8	10	fpBGA	256	208	I
	LC4512C-5T176I	512	1.8	5	TQFP	176	128	I
	LC4512C-75T176I	512	1.8	7.5	TQFP	176	128	I
	LC4512C-10T176I	512	1.8	10	TQFP	176	128	I

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000B (2.5V) Commercial Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032B	LC4032B-25T48C	32	2.5	2.5	TQFP	48	32	C
	LC4032B-5T48C	32	2.5	5	TQFP	48	32	C
	LC4032B-75T48C	32	2.5	7.5	TQFP	48	32	C
	LC4032B-25T44C	32	2.5	2.5	TQFP	44	30	C
	LC4032B-5T44C	32	2.5	5	TQFP	44	30	C
	LC4032B-75T44C	32	2.5	7.5	TQFP	44	30	C
LC4064B	LC4064B-25T100C	64	2.5	2.5	TQFP	100	64	C
	LC4064B-5T100C	64	2.5	5	TQFP	100	64	C
	LC4064B-75T100C	64	2.5	7.5	TQFP	100	64	C
	LC4064B-25T48C	64	2.5	2.5	TQFP	48	32	C
	LC4064B-5T48C	64	2.5	5	TQFP	48	32	C
	LC4064B-75T48C	64	2.5	7.5	TQFP	48	32	C
	LC4064B-25T44C	64	2.5	2.5	TQFP	44	30	C
	LC4064B-5T44C	64	2.5	5	TQFP	44	30	C
	LC4064B-75T44C	64	2.5	7.5	TQFP	44	30	C
LC4128B	LC4128B-27T128C	128	2.5	2.7	TQFP	128	92	C
	LC4128B-5T128C	128	2.5	5	TQFP	128	92	C
	LC4128B-75T128C	128	2.5	7.5	TQFP	128	92	C
	LC4128B-27T100C	128	2.5	2.7	TQFP	100	64	C
	LC4128B-5T100C	128	2.5	5	TQFP	100	64	C
	LC4128B-75T100C	128	2.5	7.5	TQFP	100	64	C

ispMACH 4000C (1.8V) Lead-Free Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4512C	LC4512C-35FTN256C	512	1.8	3.5	Lead-free ftBGA	256	208	C
	LC4512C-5FTN256C	512	1.8	5	Lead-free ftBGA	256	208	C
	LC4512C-75FTN256C	512	1.8	7.5	Lead-free ftBGA	256	208	C
	LC4512C-35FN256C ¹	512	1.8	3.5	Lead-free fpBGA	256	208	C
	LC4512C-5FN256C ¹	512	1.8	5	Lead-free fpBGA	256	208	C
	LC4512C-75FN256C ¹	512	1.8	7.5	Lead-free fpBGA	256	208	C
	LC4512C-35TN176C	512	1.8	3.5	Lead-free TQFP	176	128	C
	LC4512C-5TN176C	512	1.8	5	Lead-free TQFP	176	128	C
LC4512C-75TN176C	512	1.8	7.5	Lead-free TQFP	176	128	C	

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000C (1.8V) Lead-Free Industrial Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032C	LC4032C-5TN48I	32	1.8	5	Lead-free TQFP	48	32	I
	LC4032C-75TN48I	32	1.8	7.5	Lead-free TQFP	48	32	I
	LC4032C-10TN48I	32	1.8	10	Lead-free TQFP	48	32	I
	LC4032C-5TN44I	32	1.8	5	Lead-free TQFP	44	30	I
	LC4032C-75TN44I	32	1.8	7.5	Lead-free TQFP	44	30	I
	LC4032C-10TN44I	32	1.8	10	Lead-free TQFP	44	30	I
LC4064C	LC4064C-5TN100I	64	1.8	5	Lead-free TQFP	100	64	I
	LC4064C-75TN100I	64	1.8	7.5	Lead-free TQFP	100	64	I
	LC4064C-10TN100I	64	1.8	10	Lead-free TQFP	100	64	I
	LC4064C-5TN48I	64	1.8	5	Lead-free TQFP	48	32	I
	LC4064C-75TN48I	64	1.8	7.5	Lead-free TQFP	48	32	I
	LC4064C-10TN48I	64	1.8	10	Lead-free TQFP	48	32	I
	LC4064C-5TN44I	64	1.8	5	Lead-free TQFP	44	30	I
	LC4064C-75TN44I	64	1.8	5	Lead-free TQFP	44	30	I
LC4064C-10TN44I	64	1.8	10	Lead-free TQFP	44	30	I	
LC4128C	LC4128C-5TN128I	128	1.8	5	Lead-free TQFP	128	92	I
	LC4128C-75TN128I	128	1.8	7.5	Lead-free TQFP	128	92	I
	LC4128C-10TN128I	128	1.8	10	Lead-free TQFP	128	92	I
	LC4128C-5TN100I	128	1.8	5	Lead-free TQFP	100	64	I
	LC4128C-75TN100I	128	1.8	7.5	Lead-free TQFP	100	64	I
	LC4128C-10TN100I	128	1.8	10	Lead-free TQFP	100	64	I

ispMACH 4000C (1.8V) Lead-Free Industrial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4256C	LC4256C-5FTN256AI	256	1.8	5	Lead-free ftBGA	256	128	I
	LC4256C-75FTN256AI	256	1.8	7.5	Lead-free ftBGA	256	128	I
	LC4256C-10FTN256AI	256	1.8	10	Lead-free ftBGA	256	128	I
	LC4256C-5FTN256BI	256	1.8	5	Lead-free ftBGA	256	160	I
	LC4256C-75FTN256BI	256	1.8	7.5	Lead-free ftBGA	256	160	I
	LC4256C-10FTN256BI	256	1.8	10	Lead-free ftBGA	256	160	I
	LC4256C-5FN256AI ¹	256	1.8	5	Lead-free fpBGA	256	128	I
	LC4256C-75FN256AI ¹	256	1.8	7.5	Lead-free fpBGA	256	128	I
	LC4256C-10FN256AI ¹	256	1.8	10	Lead-free fpBGA	256	128	I
	LC4256C-5FN256BI ¹	256	1.8	5	Lead-free fpBGA	256	160	I
	LC4256C-75FN256BI ¹	256	1.8	7.5	Lead-free fpBGA	256	160	I
	LC4256C-10FN256BI ¹	256	1.8	10	Lead-free fpBGA	256	160	I
	LC4256C-5TN176I	256	1.8	5	Lead-free TQFP	176	128	I
	LC4256C-75TN176I	256	1.8	7.5	Lead-free TQFP	176	128	I
	LC4256C-10TN176I	256	1.8	10	Lead-free TQFP	176	128	I
	LC4256C-5TN100I	256	1.8	5	Lead-free TQFP	100	64	I
LC4256C-75TN100I	256	1.8	7.5	Lead-free TQFP	100	64	I	
LC4256C-10TN100I	256	1.8	10	Lead-free TQFP	100	64	I	
LC4384C	LC4384C-5FTN256I	384	1.8	5	Lead-free ftBGA	256	192	I
	LC4384C-75FTN256I	384	1.8	7.5	Lead-free ftBGA	256	192	I
	LC4384C-10FTN256I	384	1.8	10	Lead-free ftBGA	256	192	I
	LC4384C-5FN256I ¹	384	1.8	5	Lead-free fpBGA	256	192	I
	LC4384C-75FN256I ¹	384	1.8	7.5	Lead-free fpBGA	256	192	I
	LC4384C-10FN256I ¹	384	1.8	10	Lead-free fpBGA	256	192	I
	LC4384C-5TN176I	384	1.8	5	Lead-free TQFP	176	128	I
	LC4384C-75TN176I	384	1.8	7.5	Lead-free TQFP	176	128	I
LC4384C-10TN176I	384	1.8	10	Lead-free TQFP	176	128	I	
LC4512C	LC4512C-5FTN256I	512	1.8	5	Lead-free ftBGA	256	208	I
	LC4512C-75FTN256I	512	1.8	7.5	Lead-free ftBGA	256	208	I
	LC4512C-10FTN256I	512	1.8	10	Lead-free ftBGA	256	208	I
	LC4512C-5FN256I ¹	512	1.8	5	Lead-free fpBGA	256	208	I
	LC4512C-75FN256I ¹	512	1.8	7.5	Lead-free fpBGA	256	208	I
	LC4512C-10FN256I ¹	512	1.8	10	Lead-free fpBGA	256	208	I
	LC4512C-5TN176I	512	1.8	5	Lead-free TQFP	176	128	I
	LC4512C-75TN176I	512	1.8	7.5	Lead-free TQFP	176	128	I
LC4512C-10TN176I	512	1.8	10	Lead-free TQFP	176	128	I	

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000V (3.3V) Lead-Free Extended Temperature Devices

Device	Part Number	Macrocells	Voltage	t _{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-75TN48E	32	3.3	7.5	Lead-free TQFP	48	32	E
	LC4032V-75TN44E	32	3.3	7.5	Lead-free TQFP	44	30	E
LC4064V	LC4064V-75TN100E	64	3.3	7.5	Lead-free TQFP	100	64	E
	LC4064V-75TN48E	64	3.3	7.5	Lead-free TQFP	48	32	E
	LC4064V-75TN44E	64	3.3	7.5	Lead-free TQFP	44	30	E
LC4128V	LC4128V-75TN144E	128	3.3	7.5	Lead-free TQFP	144	96	E
	LC4128V-75TN128E	128	3.3	7.5	Lead-free TQFP	128	92	E
	LC4128V-75TN100E	128	3.3	7.5	Lead-free TQFP	100	64	E
LC4256V	LC4256V-75TN176E	256	3.3	7.5	Lead-free TQFP	176	128	E
	LC4256V-75TN144E	256	3.3	7.5	Lead-free TQFP	144	96	E
	LC4256V-75TN100E	256	3.3	7.5	Lead-free TQFP	100	64	E

For Further Information

In addition to this data sheet, the following technical notes may be helpful when designing with the ispMACH 4000V/B/C/Z family:

- TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#)
- TN1005, [Power Estimation in ispMACH 4000V/B/C/Z Devices](#)

Revision History

Date	Version	Change Summary
—	—	Previous Lattice releases.
July 2003	17z	Changed device status for LC4064ZC and LC4128ZC to production release and updated/added AC and DC parameters as well as ordering part numbers for LC4064ZC and LC4128ZC devices.
		Improved leakage current specifications for ispMACH 4000Z. For ispMACH 4000V/B/C IIL, IIH condition now includes 0V and 3.6V end points ($0 \leq V_{IN} \leq 3.6V$).
		Added 132-ball chip scale BGA power supply and NC connections.
		Added 132-ball chip scale BGA logic signal connections for LC4064ZC, LC4128ZC and LC4256ZC devices.
		Added lead-free package designators.
October 2003	18z	Hot socketing characteristics footnote 1. has been enhanced; Insensitive to sequence of VCC or VCCO. However, assumes monotonic rise/fall rates for Vcc and Vcco, provided ($V_{IN} - V_{CCO}$) \leq 3.6V.
		Improved LC4064ZC t _S to 2.5ns, t _{ST} to 2.7ns and f _{MAX} (Ext.) to 175MHz, LC4128ZC t _{CO} to 3.5ns and f _{MAX} (Ext.) to 161MHz (version v.2.1).
		Improved associated internal timing numbers and timing adders (version v.2.1).
		Added ispMACH 4000V/B/C/Z ORP Reference Tables.
		Enhanced ORP information in device pinout tables consistent with the ORP Combinations for I/O Blocks tables (table 6, 7, 8 and 9 in page 9-11).
		Corrected GLB/MC/Pad information in the 256-fpBGA pinouts for the LC4256V/B/C 160-I/O version.
		Added the ispMACH 4000 Family Speed Grade Offering table.
		Added the ispMACH 4128ZC Industrial and Automotive Device OPNs
December 2003	19z	Added the ispMACH 4032ZC and 4064ZC Industrial and Automotive Device OPNs